

SN65220, SN65240, SN75240 SINGLE AND DUAL UNIVERSAL SERIAL BUS PORT TRANSIENT SUPPRESSORS

SLLS266C – FEBRUARY 1997 – REVISED MARCH 2000

- Design to Protect Submicron 3-V or 5-V Silicon from Noise Transients
- Applicable to Two High- or Low-Speed Universal Serial Bus (USB) Host, Hub, or Peripheral Ports
- Port ESD Protection Capability Exceeds:
 - 15-kV Human Body Model
 - 2-kV Machine Model
- Low Current Leakage . . . 1 μ A Max
- Stand-Off Voltage . . . 6.0 V Min
- Low Capacitance . . . 35 pF Typ

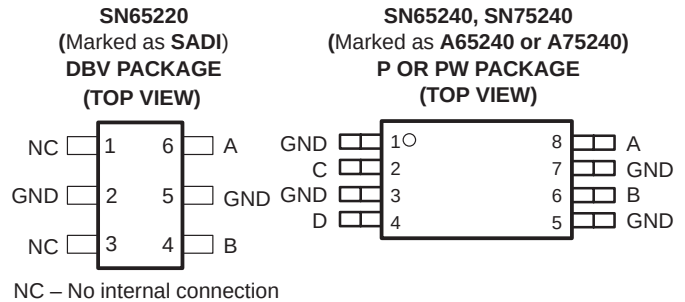
description

The SN65220 is a single transient voltage suppressor and the SN75240 and SN65240 are dual transient voltage suppressors designed to provide additional electrical noise transient protection to two USB ports. Any cabled I/O can be subjected to electrical noise transients from various sources. These noise transients can cause damage to the USB transceiver and/or the USB ASIC if they are of sufficient magnitude and duration. The USB ports are typically implemented in 3-V or 5-V digital CMOS with very limited ESD protection. The SN65220, SN75240, and SN65240 can significantly increase the port ESD protection level and reduce the risk of damage to the large and expensive circuits of the USB port.

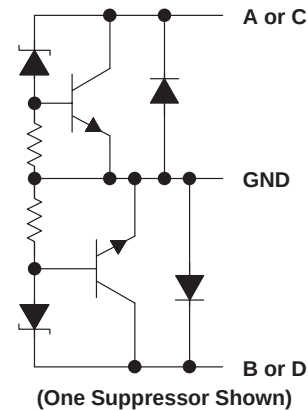
The SN75240 is characterized for operation from 0°C to 70°C. The SN65220 and SN65240 are characterized for operation from –40°C to 85°C. IEC1000-4-2 ESD performance is measured at the system level and system design influences the results of these tests. A high compliance level may be attained with proper system design.

IEC1000-4-2 Compliance Test Levels

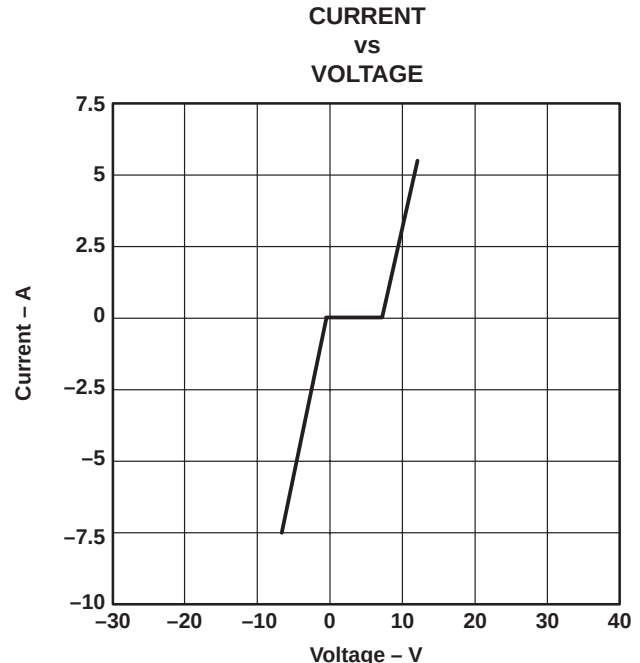
IEC1000-4-2 COMPLIANCE LEVEL	MAXIMUM TEST VOLTAGE	
	CONTACT DISCHARGE (kV)	AIR DISCHARGE (kV)
1	2	2
2	4	4
3	6	8
4	8	15



schematic



NOTE A: All four GND terminals should be connected to ground.



NOTE A: Typical current versus voltage curve was derived using the IEC 1.2/50- μ s surge waveform.



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Continuous total power dissipation	See Dissipation Rating Table
Electrostatic discharge	Class 3, A:15 kV, B: 2 kV
Peak power dissipation, P _{D(peak)}	60 W
Peak forward surge current, I _{FSM}	3 A
Peak reverse surge current, I _{RSM}	–9 A
Storage temperature range, T _{stg}	–65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

DISSIPATION RATING TABLE

PACKAGE	T _A ≤ 25°C POWER RATING	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING	T _A = 85°C POWER RATING
DBV	385 mW	3.1 mW/°C	246 mW	200 mW
P	1150 mW	9.2 mW/°C	736 mW	598 mW
PW	520 mW	4.2 mW/°C	331 mW	268 mW

[‡] This is the inverse of the junction-to-ambient thermal resistance when board-mounted and with no air flow.

recommended operating conditions

		MIN	MAX	UNIT
Operating free-air temperature, T _A	SN65240, SN65220	–40	85	°C
	SN75240	0	70	

electrical characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
I _{lkg} Leakage current	V _I = 6 V at A, B, C, or D terminals			1	μA
V _(BR) Breakdown voltage	V _I = 1 mA at A, B, C, or D terminals		7		V

APPLICATION INFORMATION

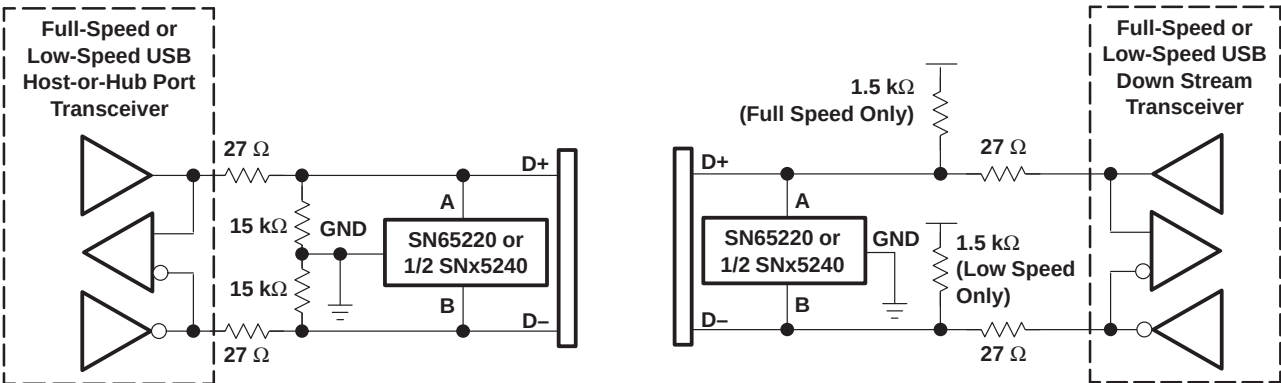


Figure 1. Typical USB Application

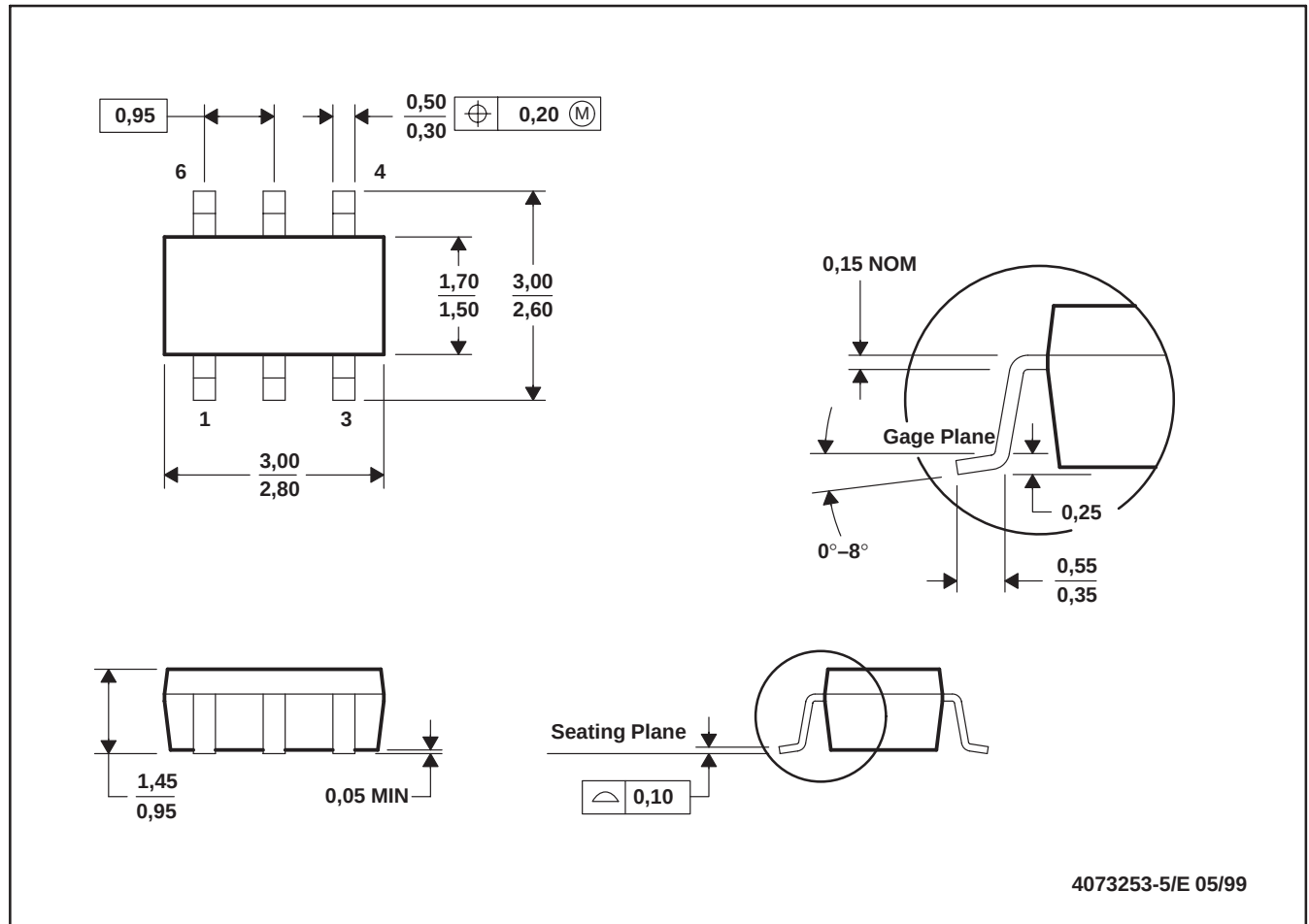
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MECHANICAL INFORMATION

DBV (R-PDSO-G6)

PLASTIC SMALL-OUTLINE



- NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion.

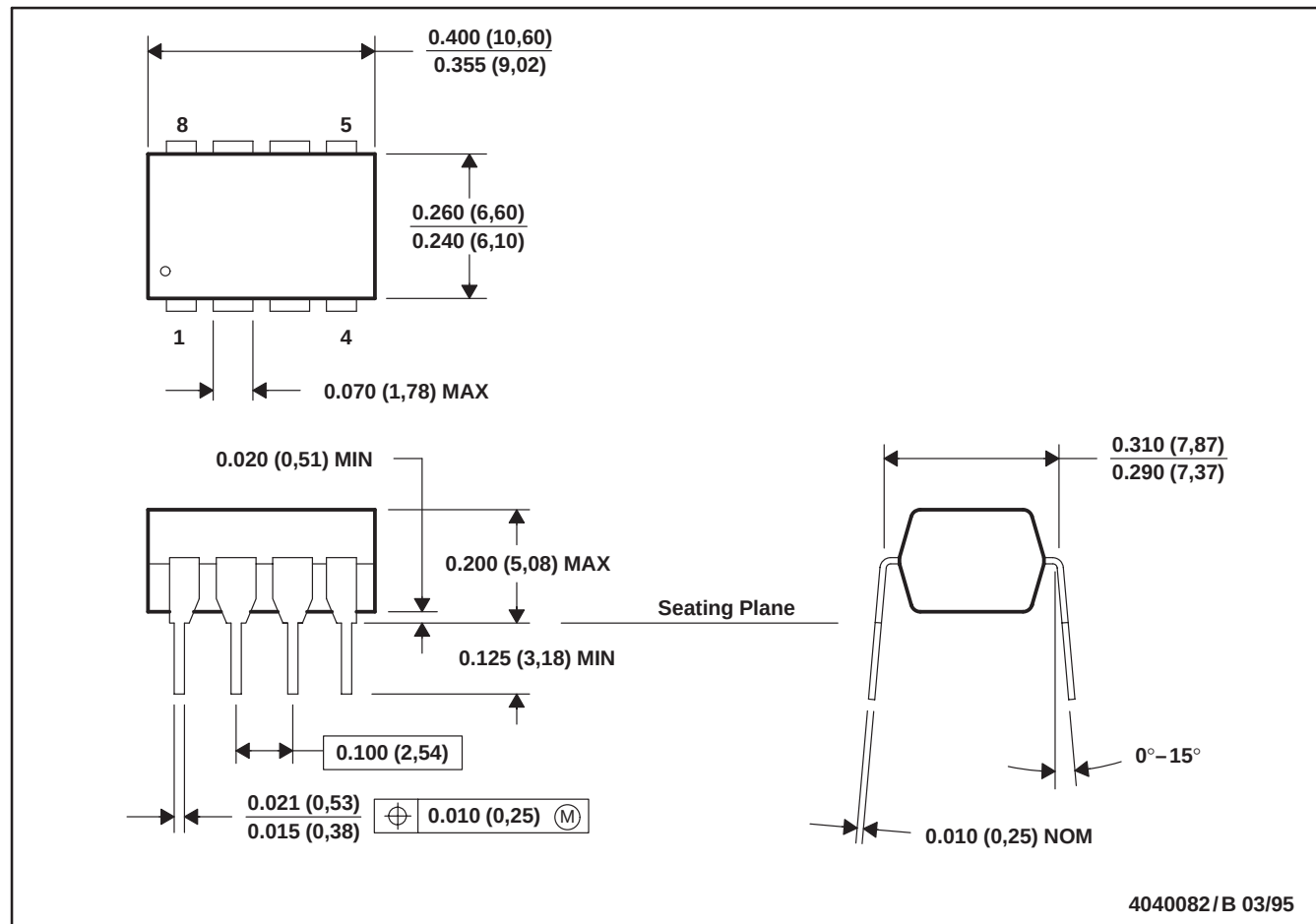
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MECHANICAL INFORMATION

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



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C. Falls within JEDEC MS-001

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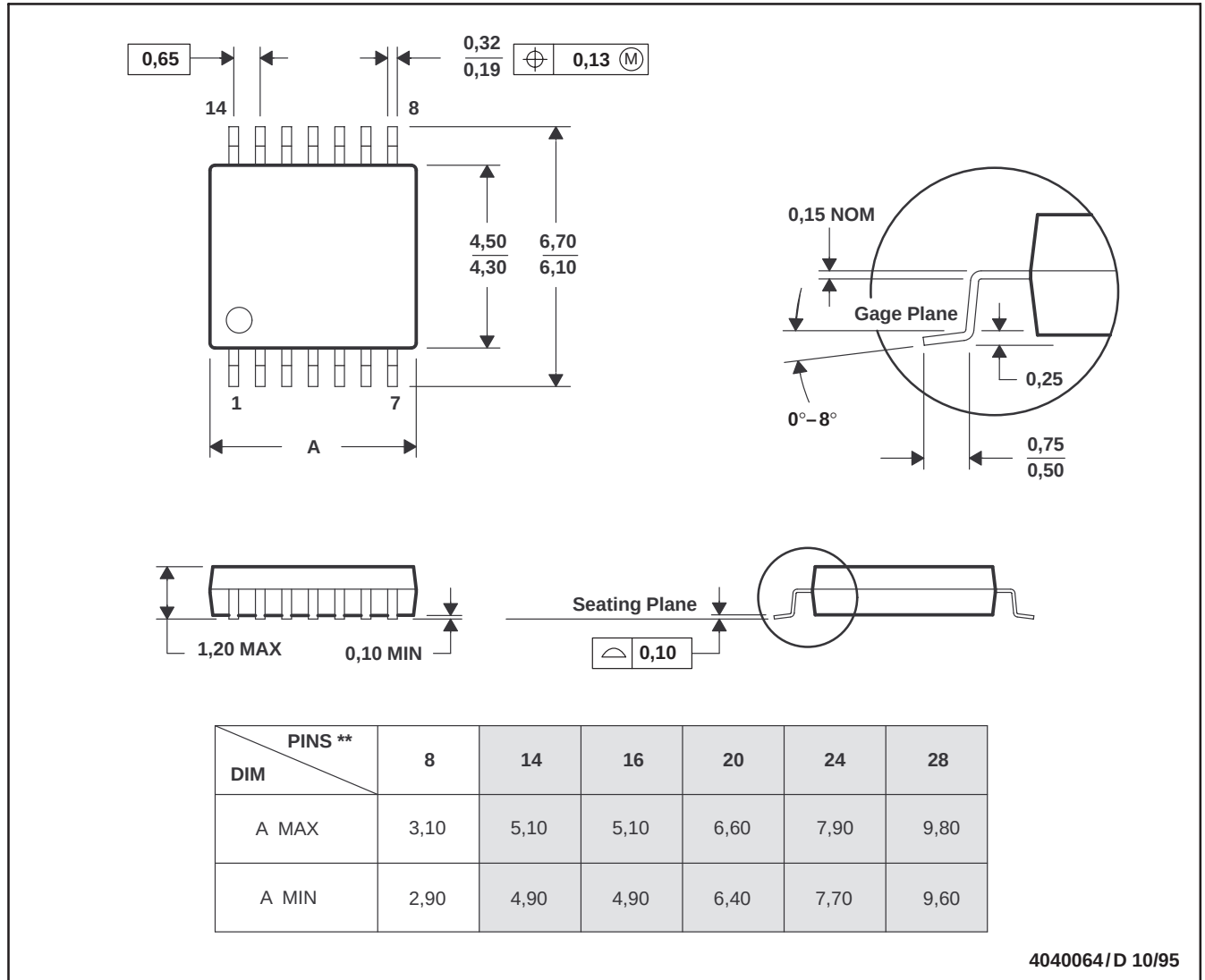
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MECHANICAL INFORMATION

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PIN SHOWN



- NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
D. Falls within JEDEC MO-153

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